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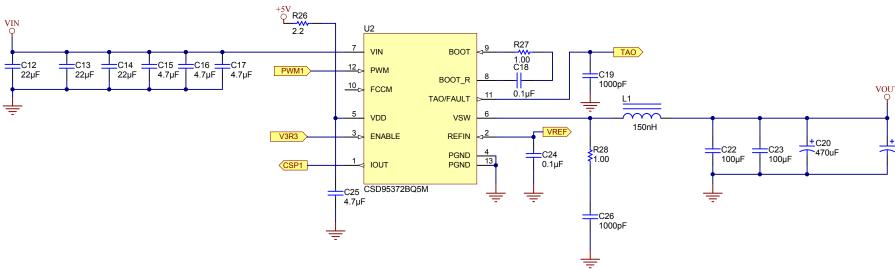
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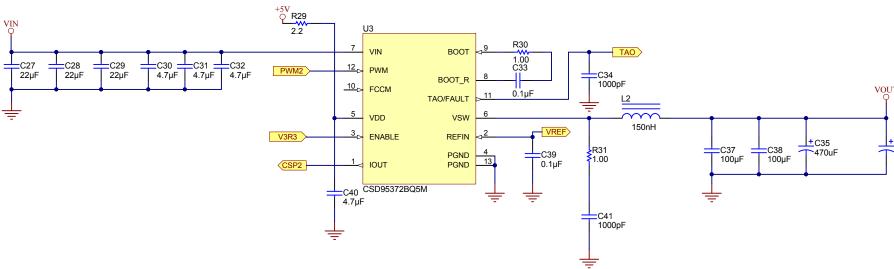
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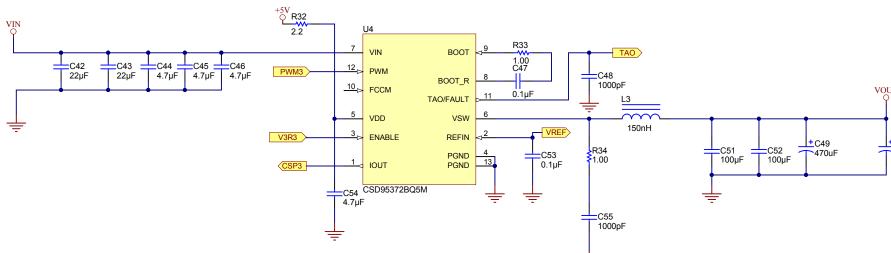
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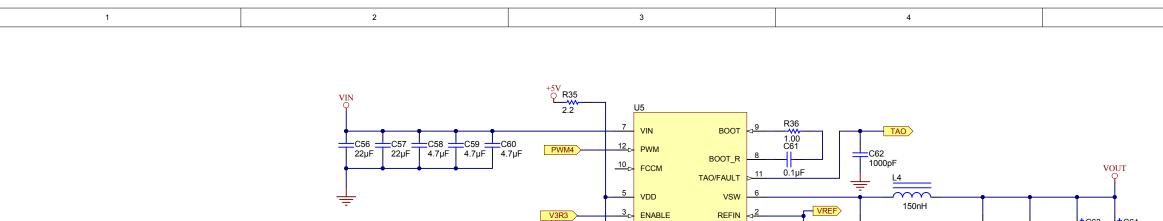




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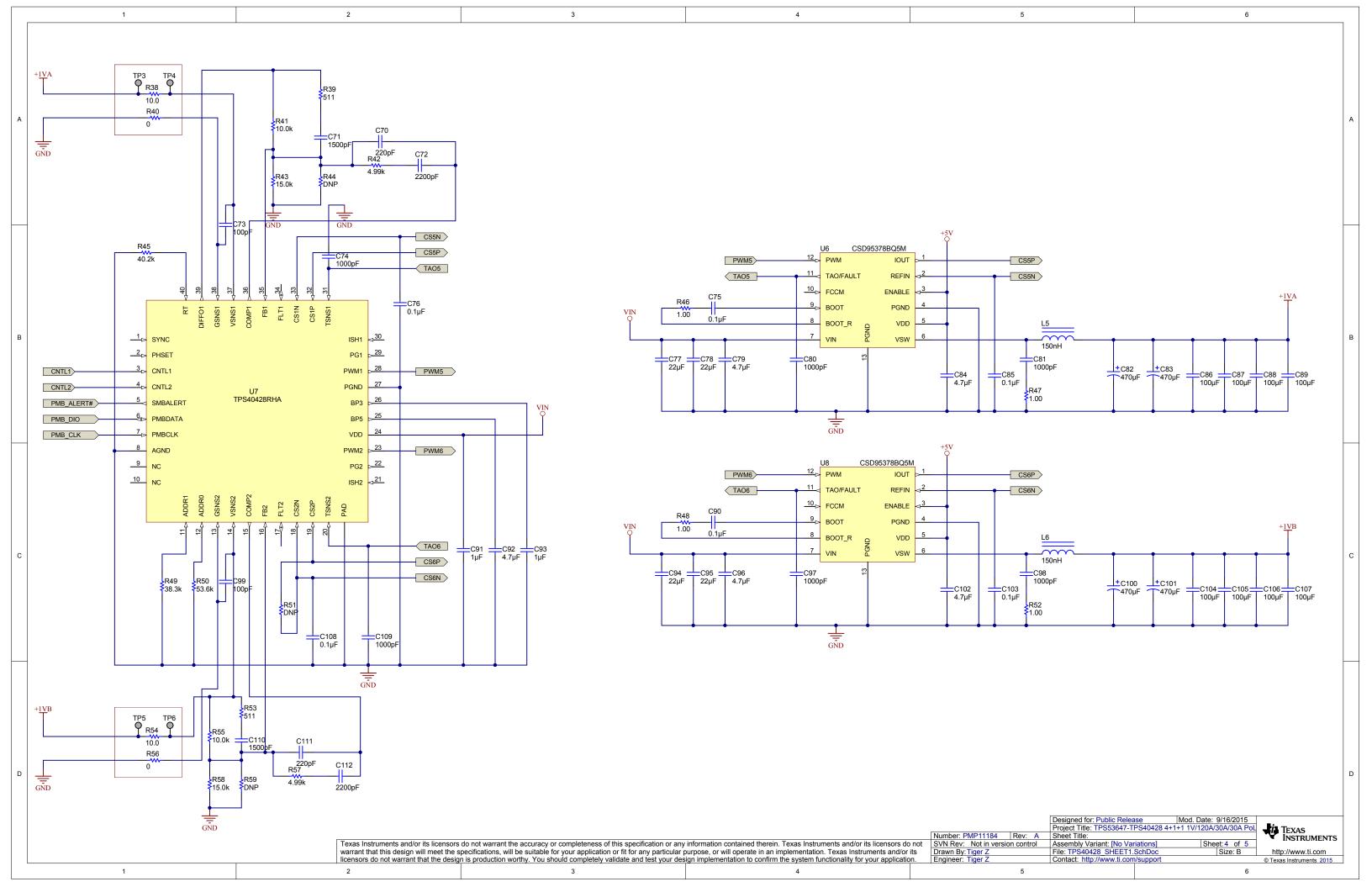
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erable Designed for: Public Release Mod. Date: 9/16/2015 Project Title: TPS53647-TPS40428 4+1+1 1V/120A/30A/30A Pol Rev: A Sheet Title: power stage section File: CSD95372B Power Stage2.SchDoc Size: B http://www.ti.com Contact: http://www.ti.com/support © Texas Instruments 2015



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